

Doc code :IDS

Doc description: Information Disclosure Statement (IDS) Filed

PTO/SB/08a (10-08)

Approved for use through 11/30/2008. OMB 0651-0031

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INFORMATION DISCLOSURE STATEMENT BY APPLICANT <i>(Not for submission under 37 CFR 1.99)</i>	Application Number	10585275
	Filing Date	2006-07-05
	First Named Inventor	Nancy Dean
	Art Unit	2835
	Examiner Name	Unknown
	Attorney Docket Number	H0005430.75230 USA -4018

U.S.PATENTS

Examiner Initial*	Cite No	Patent Number	Kind Code ¹	Issue Date	Name of Patentee or Applicant of cited Document	Pages,Columns,Lines where Relevant Passages or Relevant Figures Appear
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